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Guest Editorial

Microchannels: Rapid Growth of a Nascent Technology

Satish G. Kandlikar

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Research Papers

Effects of Axial Corrugated Roughness on Low Reynolds Number Slip Flow and Continuum Flow in Microtubes

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Flow Boiling on Micropin Fins Entrenched Inside a Microchannel—Flow Patterns and Bubble Departure Diameter and Bubble Frequency

Santosh Krishnamurthy and Yoav Peles

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Generalized Two-Phase Pressure Drop and Heat Transfer Correlations in Evaporative Micro/Minichannels

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Representative Results for Condensation Measurements at Hydraulic Diameters~100 Microns

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Analytical Modeling of Annular Flow Boiling Heat Transfer in Mini- and Microchannel Heat Sinks

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